Long Pulse Modulators



Hans-Jörg Eckoldt CERN Accelerator School Baden, May 2014





Structure

- > Why long pulses?
- > Where are long pulse modulators used?
 - Basics
 - RF-Station
 - Klystron
- Modulators
 - Passive components
 - Active components
- Connection to the mains
- > EMI aspects
- > Next developments





Why long pulses?

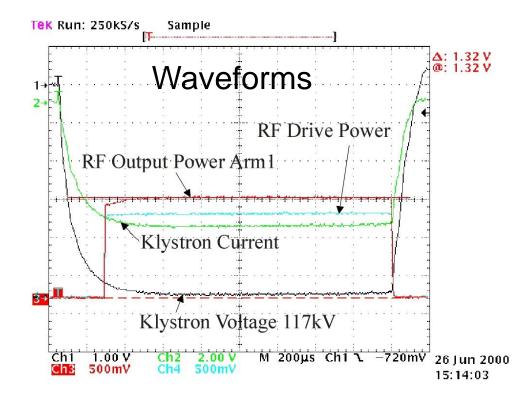
- At DESY the start of investigating long pulse modulators began with the R&D of superconducting cavities in the early 90th at the TESLA Test Facility. (Superconducting linear accelerator facility).
- Since the cavities cannot withstand this this power in CW the machine is pulsed.
- > The cryo system is not able to cool this down.
- > The pulse duration is determined by:
 - The modulator voltage has a rise time of 200 300 μs
 - A superconducting cavity has a loading time of about 500 µs.
 - The bunch train of particles should be around 800 μs.
- > The design aim was defined to be 1.7 ms.







The first modulators built by FNAL



First modulator was commissioned in 1994



FNAL Modulator at TTF





Basics of modulator

- > The units producing the pulsed power are called modulators.
- The modulator takes power from the grid and delivers HV-pulses to the load.
- > The modulator is part of an RF-station.
- During the pulse the power is up to several MW
- The average power of a modulator is low in comparison to the pulsed power.
- Pulse width is up to several milliseconds (e.g. XFEL 1.54ms, ESS 3.5ms, SNS 1.35ms).



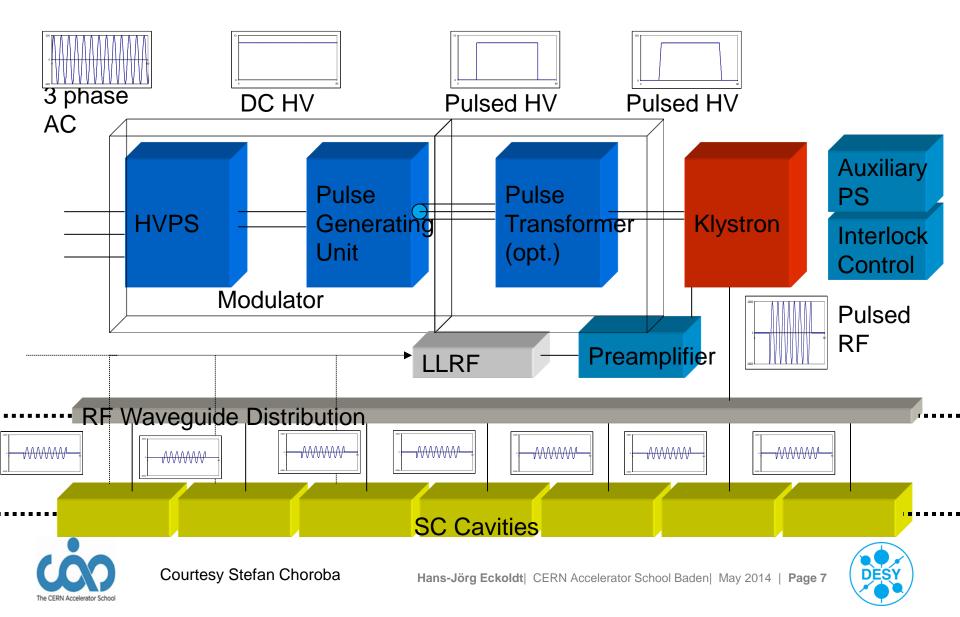


Where are modulators used?





XFEL RF Station Components



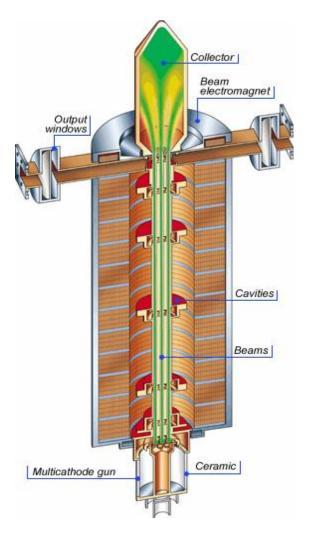
Load

- The modulator is part of an RF-Station
- > The usual load is a klystron.
- The klystron is a linear-beam vacuum tube. It is used to amplify RFsignals.
- Low RF-power is introduced, high RF-power is taken from the klystron to feed the cavities





Klystron Principle



The CERN Accelerator Scho

•The cathode is heated by the heater to ~1000°C.

•The cathode is then charged (pulsed or DC) to several 100kV.

•Electrons are accelerated form the cathode towards the anode at ground, which is isolated from the cathode by the high voltage ceramics.

•The electron beam passes the anode hole and drifts in the drift tube to the collector.

•The beam is focused by a bucking coil and a solenoid.

•By applying RF power to the RF input cavity the beam is velocity modulated.

•On its way to the output cavity the velocity modulation converts to a density modulation. This effect is reinforced by additional buncher and gain cavities.

•The density modulation in the output cavity excites a strong RF oscillation in the output cavity.

•RF power is coupled out via the output waveguides and the windows.

•Vacuum pumps sustain the high vacuum in the klystron envelope.

•The beam is finally dumped in the collector, where it generates X-rays which must be shielded by lead.



Typical data of available klystrons

- Klystron today
 - Frequency Range: \sim 350MHz to \sim 17GHz XFEL 1.3 GHz
 - Output Power:

- up to ~1.3MW CW: Pulsed: up to ~200MW at ~1 μ s up to ~10MW at ~1ms

Klystron Gun Voltage:

DC: ~100kV Pulsed: ~600kV at ~1µs \sim 130kV at \sim 1ms





Electrical behavior of a klystron

The relation of current to voltage is

$$I = \mu P * U^{3/2}$$

- The µperveance is a parameter of the klystron gun. This is determined by the geometry and fixed for the klystron, U= klystron voltage, I is the klystron current
- > Beam power

$$P_{Beam} = \mu P * U^{5/2}$$

RF power

$$P_{RF} = \eta P_{Beam}$$

η is the efficiency of the klystron





Electrical data:

Cathode Voltage: 117kV Beam current: 131A 3.27 μ Perveance: Electrical resistance: Max. RF peak power: 10MW **Electrical power:** RF Pulse duration: **Repetition Rate:** 10Hz Efficiency: 65 % **RF** Average Power: 150kW Average electr. power: 230 kW

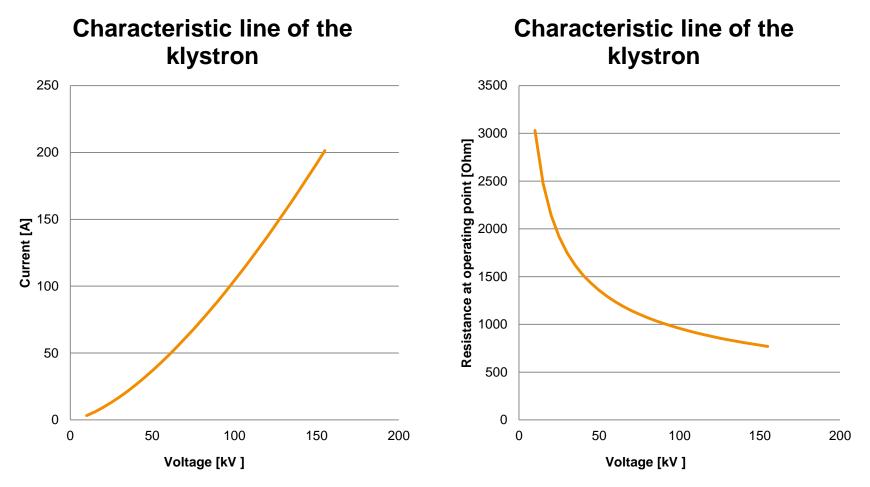
893 Ω @ 117 kV 15.33 MW 1.5ms (1.7 ms max)







Electrical behavior of the klystron



In a simulation this can be simulated as a resistor with a diode in series at the working point, or better as resistor with the characteristic line





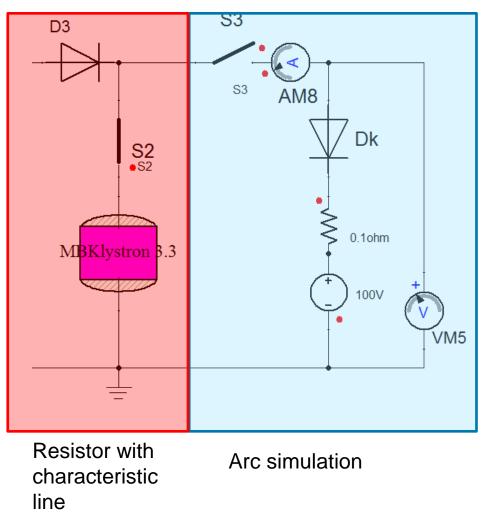
Arcing of a klystron

- During operation of a klystron arcs inside occur. In this case the HV collapses to the burning voltage of the arc.
- In case of an arc only 10 20 J are allowed to be deposited in the klystron. More energy would damage the surfaces in the klystron.
- > The modulator has to protect the klystron.
 - The energy supply has to be interrupted.
 - The energy that is stored in the devices has to be dissipated by the help of extra equipment.
- The model of the arc is a series combination of a voltage source of 100 V and a resistor for the current depending part. This resistor is assumed as 100 mΩ.





Electrical equivalent circuit of the klystron









Definition of the pulse

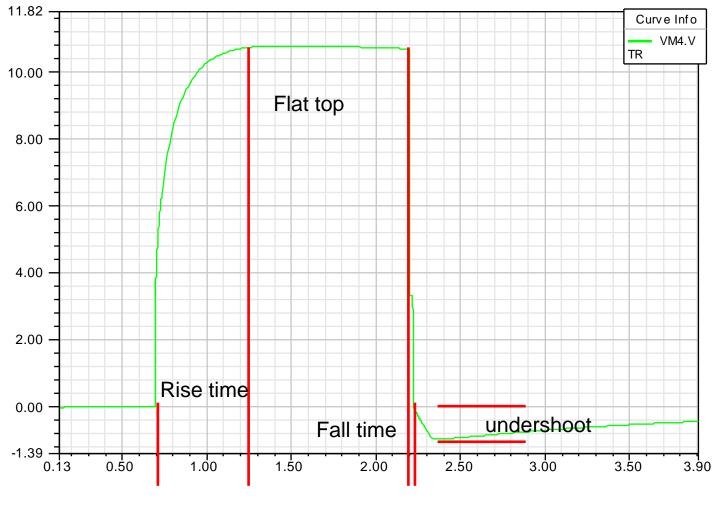
> Rise time	time from the beginning up to the flat top, often it is defined as 10% to 90 or 99%
> Flat top	time when the pulse is at the klystron operation voltage, variations lead to RF- phase shifts that have to be compensated by the LLRF. The flat top is defined as +/- x% of the voltage
> Fall time	Time the modulator voltage needs to go down
> Reverse voltage	undershoot allowed neg. voltage (about 20%)

- Repetition frequency Frequency of pulse repetition
- > Pulse to pulse stability Repetitive value of the flat top.





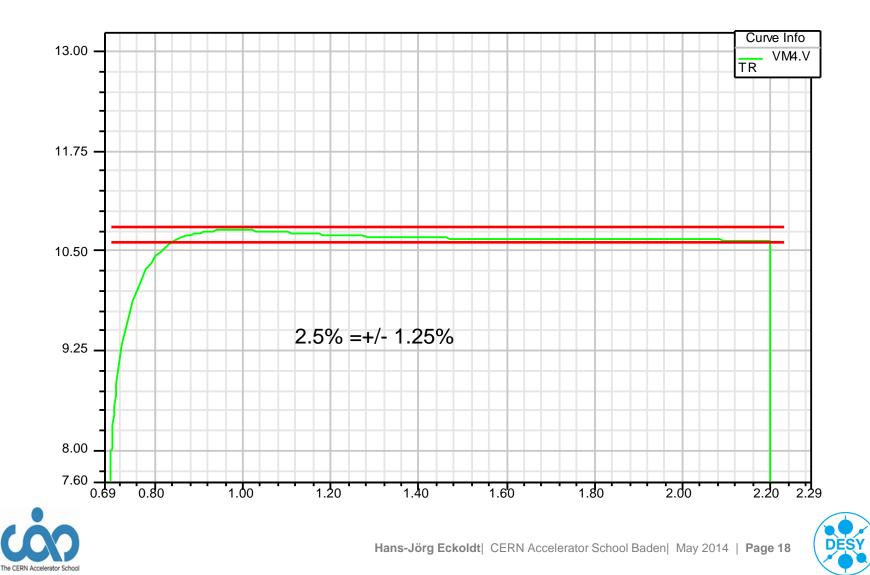
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Flatness of the pulse

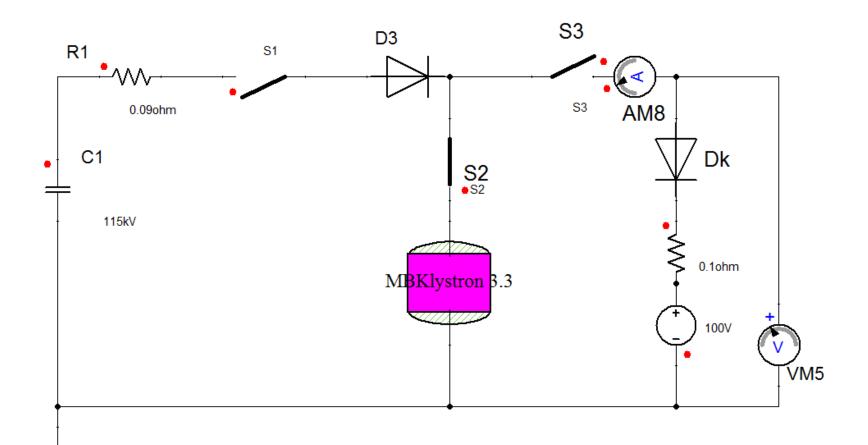


Modulator basics start with the pulse forming unit





Direct switching







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Advantage

- Simple design on schematic
- > Only few components

Disadvantage

- > High voltage at Cap-bank
- Very few suppliers of switches
- > Has to operate under oil

> High stored energy





Size of Capacitor

Pulse-Flatness = 0.5 %, exponential decay, XFEL requirements

$$U = U_0 * e^{-\frac{t}{RC}}$$
$$\Delta U = 0.5\% = 0.005$$
$$0.995 = e^{-\frac{t}{RC}}$$
$$\ln(0.995) = -t/RC$$
$$C = -t/(R \ln(0.995))$$

With U_0 = 115 kV, R= 900 Ω , t=1,7ms

$$C = 377 \,\mu F$$





Energies

Pulse energy simplified to rectangular wave form

$$E_{pulse} = U * I * t = \frac{U^2}{R} * t$$

$$E_{pulse} = \frac{115 \ kV^2}{900\Omega} * 1,7 \ ms$$

$$E_{pulse} = 24,98 \ kJ$$

Stored energy in the capacitor

$$E_{stored} = \frac{1}{2} * C * U^2$$

$$E_{stored} = \frac{1}{2} * 377 \mu F * 115 kV^2$$

$$E_{stored} = 2491,8kJ$$

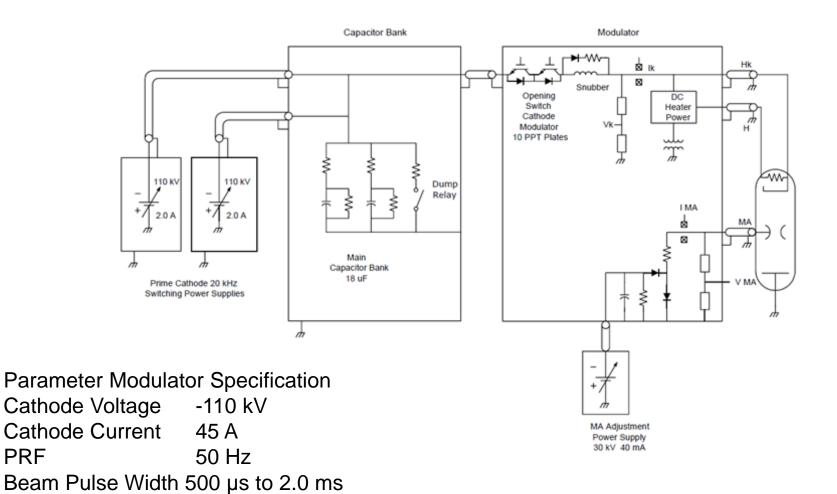
This is nearly 100 times of the required pulse energy.





Direct switch realized e.g. DTI design for ISIS front end test stand

5%



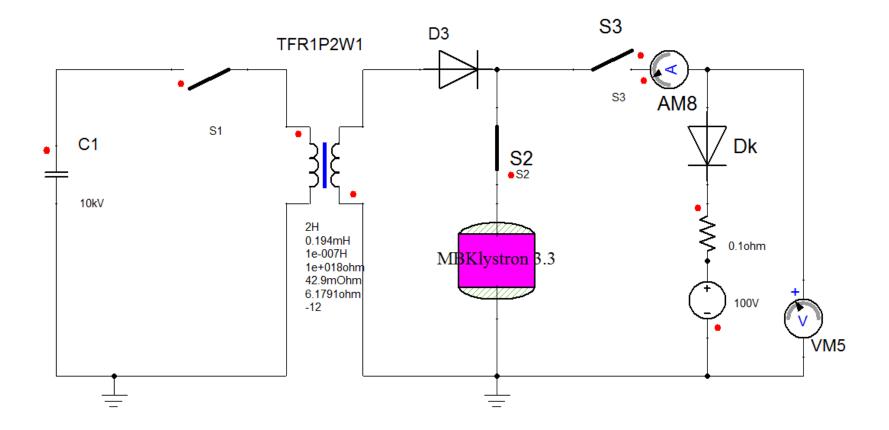
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PRF

Droop



Modulator with pulse transformer







Series switch modulator with pulse transformer

Advantage

- >Work on lower voltage level
 - At DESY 10 12 kV
 - Switch is much easier
 - No oil in modulator, but in the transformer tank

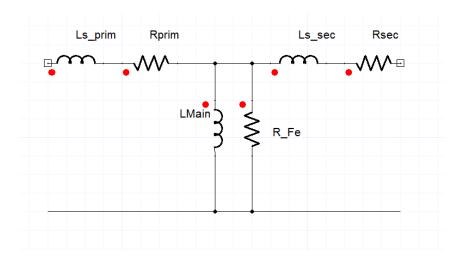
Disadvantage

- Additional pulse transformer
- Leakage inductance decreases rise time
- >Additional stored energy that has to be dissipated in case of an arc

>More stored energy



Equivalent circuit of a pulse transformer



- Transformer introduces additional inductances
- In case of an arc the energy that is stored in the stray inductances and in the main inductances has to be dissipated.
- The Rsec should be taken into account for dissipating the energy in case of an arc





Stored energy in the transformer

Stray inductance

 $E_{stored \, Ls} = \frac{1}{2} * L * I_{short \, circuit}^2$

Ls XFEL transformer = 200 μ H

$$E_{storedLs} = \frac{1}{2} * 200 \mu H * 2000 A^2$$

$$E_{storedLs} = 400J$$

> Main inductance

$$E_{stored LM} = \frac{1}{2} * L * I_{mag.}^{2}$$

Lmain XFEL transformer 5 H

$$I_{Mag} = \frac{U * t}{L}$$

U= 10 kV, t=time of arc 0-1.7ms

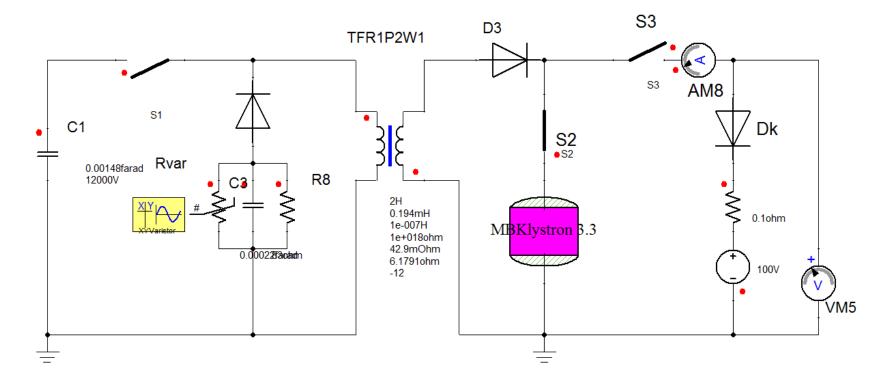
$$I_{Magmax} = \frac{10kV*1.7ms}{5H} = 3.4 \text{ A}$$
$$E_{stored LM} = \frac{1}{2}*5H*3.4A^{2} = 28.9 \text{ J}$$

Stored energy = 428.9 J





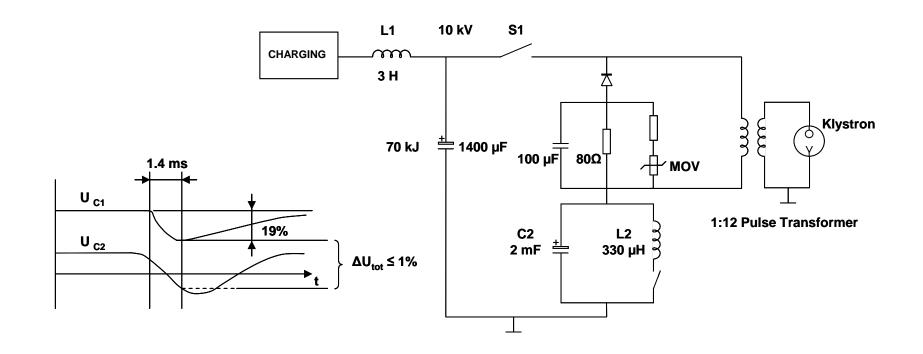
Additional discharge network to dissipate the energy



The energy is stored in a capacitor and dissipated in the parallel resistor



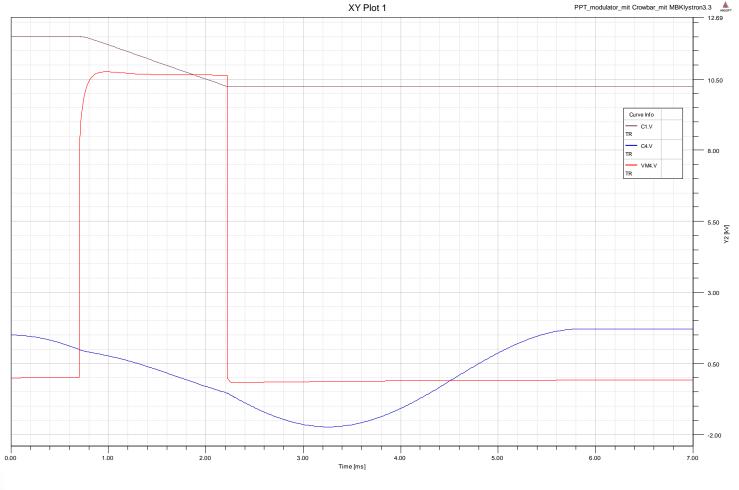








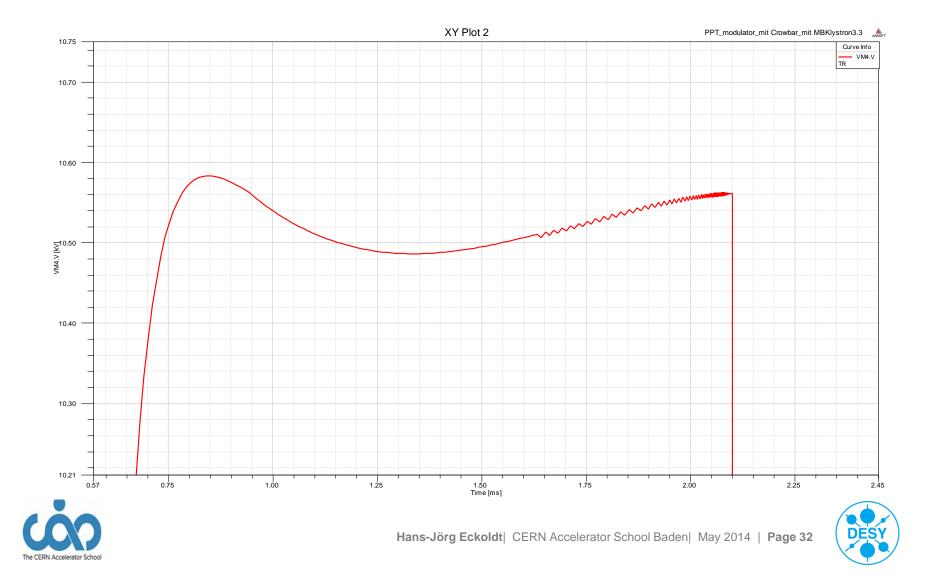
Voltages of Bouncer modulator



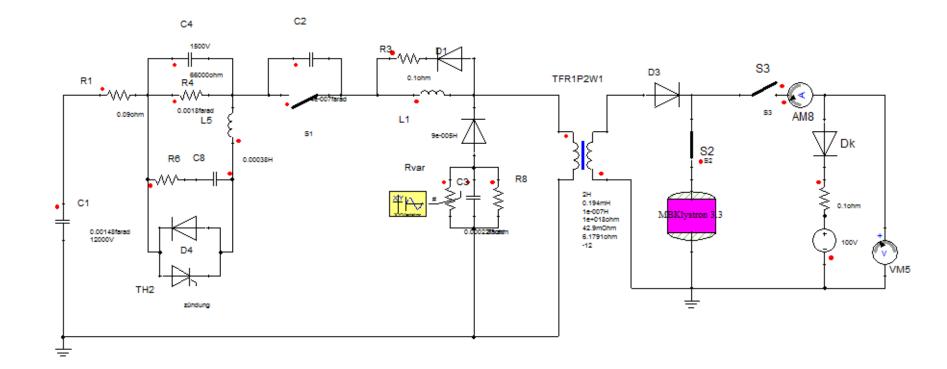




Flat top voltage



Bouncer modulator Bouncer in the high voltage path (DESY design, built by PPT)







Stored energy in bouncer modulator

Pulse energy simplified to rectangular wave form

$$E_{pulse} = U * I * t = \frac{U^2}{R} * t$$

$$E_{pulse} = \frac{115 \ kV^2}{900\Omega} * 1,7 \ ms$$

$$E_{pulse} = 24,98 \ kJ$$

Stored energy in the capacitors Main capacitor

$$E_{stored} = \frac{1}{2} * C_{main} * U^2$$

$$E_{stored} = \frac{1}{2} * 1.4 \ mF * 10 kV^2$$

$$E_{stored} = 70 \ kJ$$

Bouncer

$$E_{stored} = \frac{1}{2} * C_{bouncer} * U^2$$

$$E_{stored} = \frac{1}{2} * 2 mF * 2kV^2$$

$$E_{stored} = 4 \ kJ$$



 $E_{\text{stored total}} = 74 \text{ kJ} = 5 * E_pulse$



Bouncer modulator with pulse transformer

Advantage

- > Work on lower voltage level
 - At DESY 10 12 kV
- Switch is much easier
- No oil in modulator, but pulse transformer
- > Much lower stored energy

Disadvantage

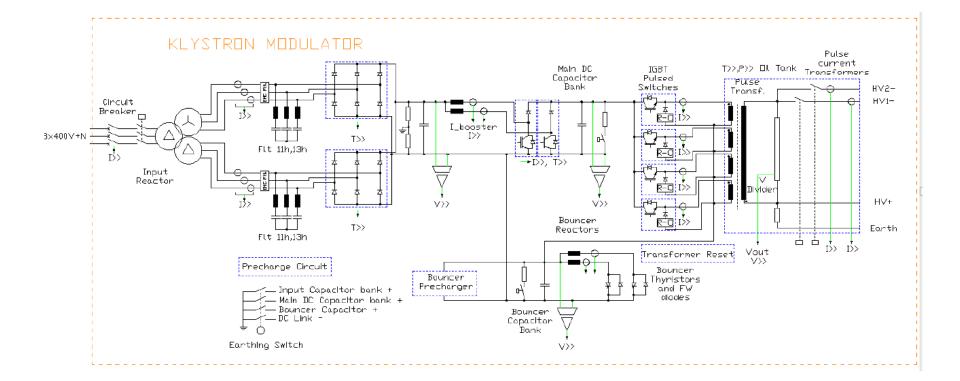
- > Additional pulse transformer
- > Leakage inductance decreases rise time
- > Additional stored energy that has to be dissipated in case of an arc

- Timing dependent bouncer switching
- > High current in the bouncer circuit





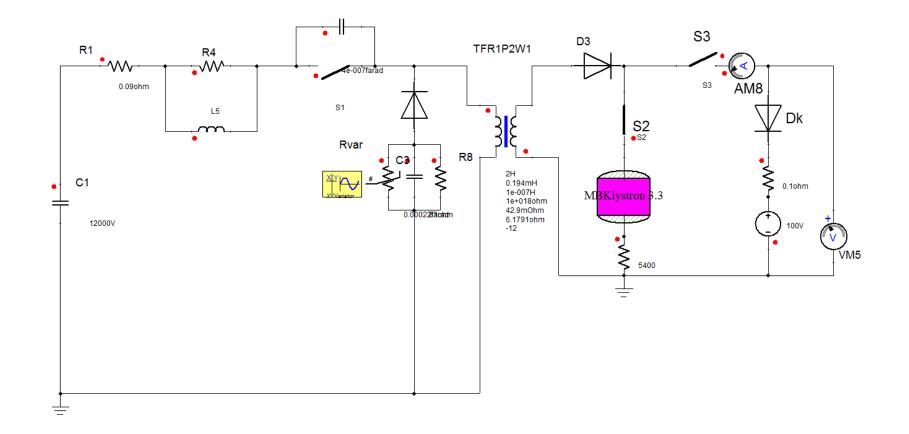
Bouncer modulator with separated primary of the transformer proposed by JEMA







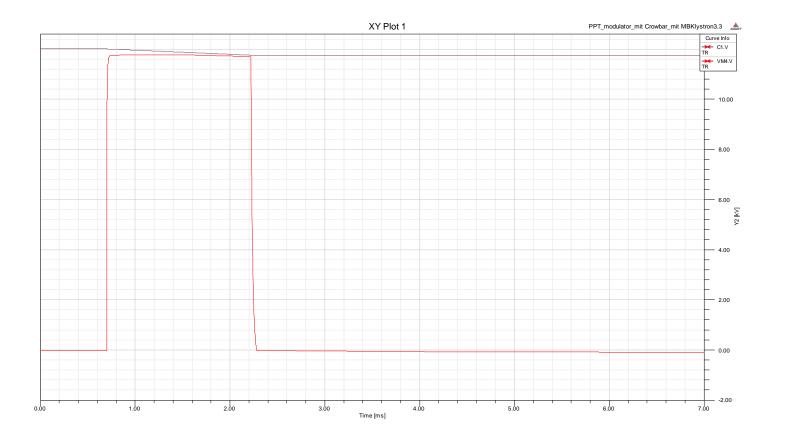
Pulsforming with series RL







Voltage of RL modulator







RL modulator with pulse transformer

Advantage

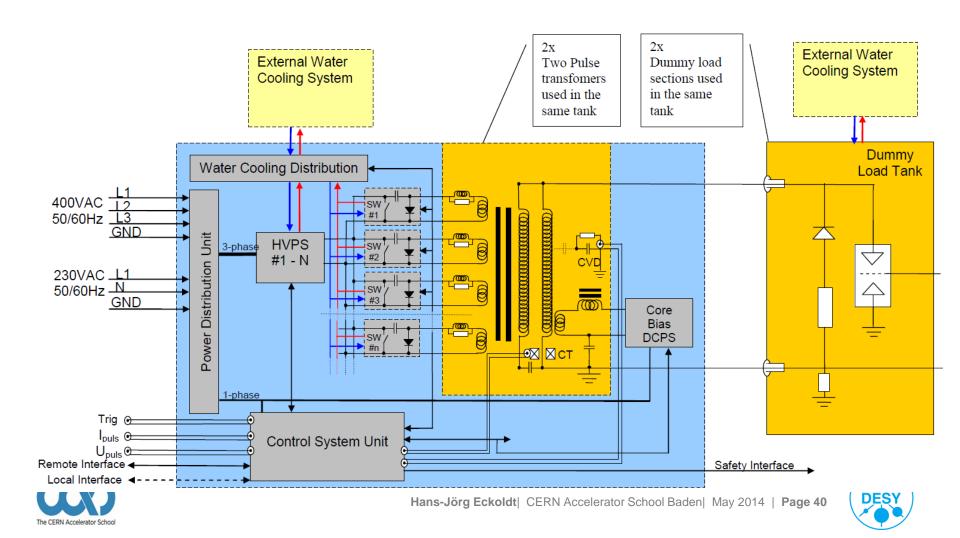
- > Work on lower voltage level
 - At DESY 10 12 kV
- Switch is much easier
- No oil in modulator, but pulse transformer
- > Much lower stored energy
- Passive pulse forming

Disadvantage

- > Additional pulse transformer
- Leakage inductance decreases rise time
- > Additional stored energy that has to be dissipated in case of an arc
- Lower flexibility than bouncer







Active voltage correction to replace LC-bouncer

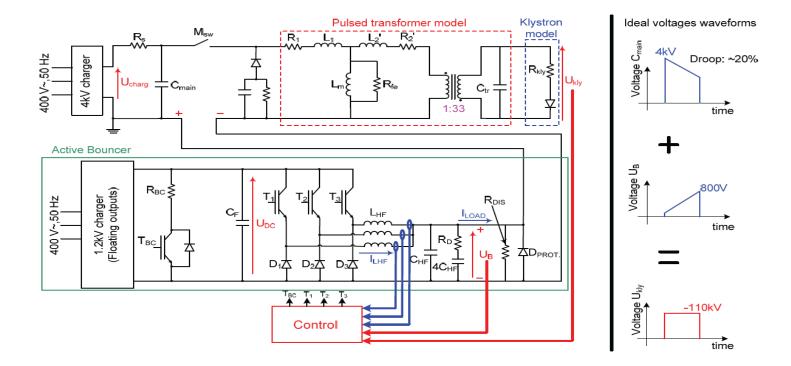
- Instead of using passive components active power supplies can be introduced.
- These have the same function as a bouncer, but have additionally the possibility to adjust during the pulse to achieve better flatness.





Active bouncer converter

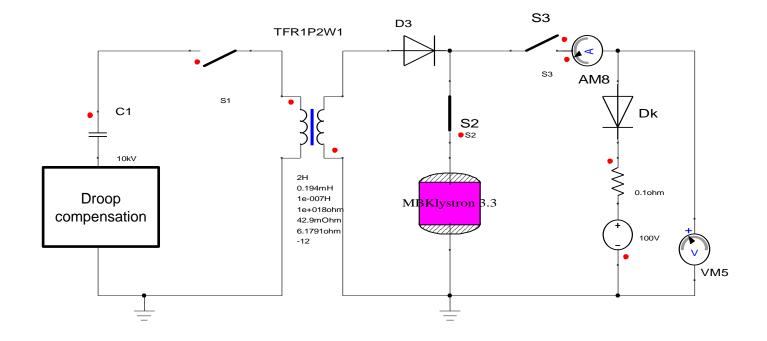
Proposed by Davide Aguglia CERN







Active bouncer converter power supply in capacitor branch





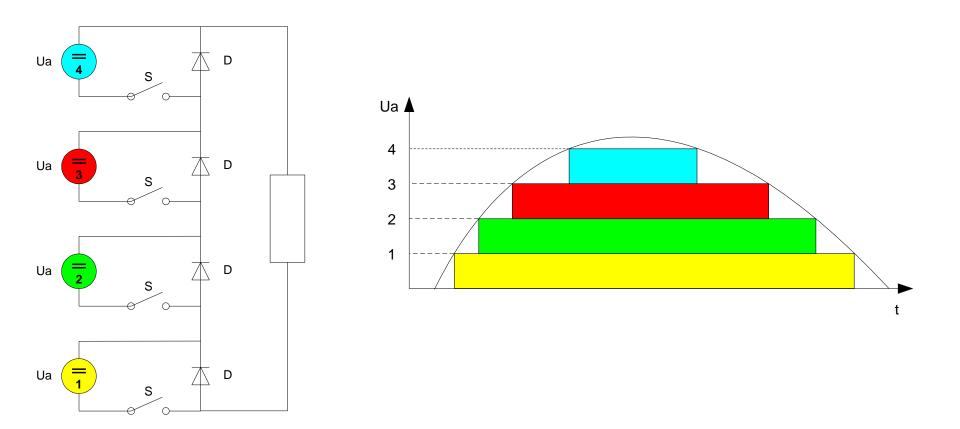


Modulators with active components



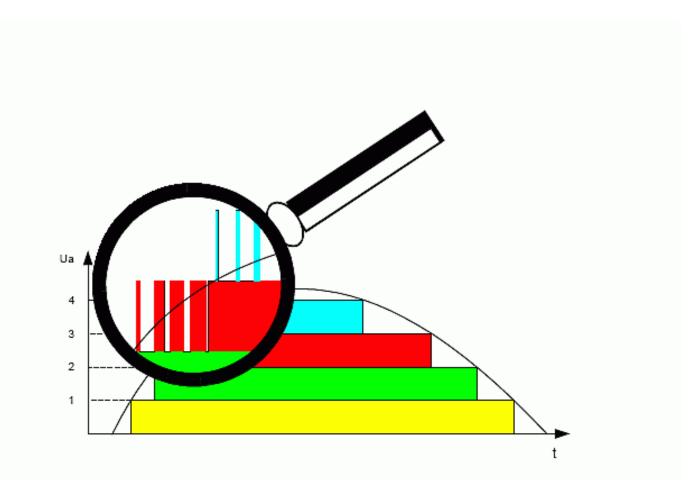


Pulse Step Modulator (PSM) design by Ampegon





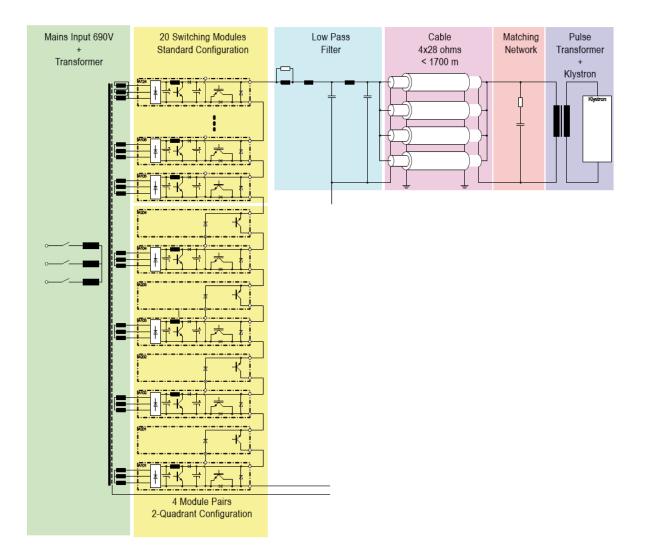








Ampegon modulator for XFEL





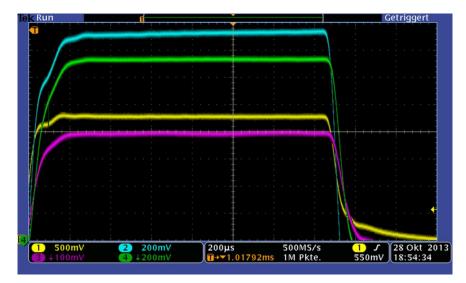


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Ampegon modulator for XFEL

> Waveforms of modulator

> Flat top 30 Vpp

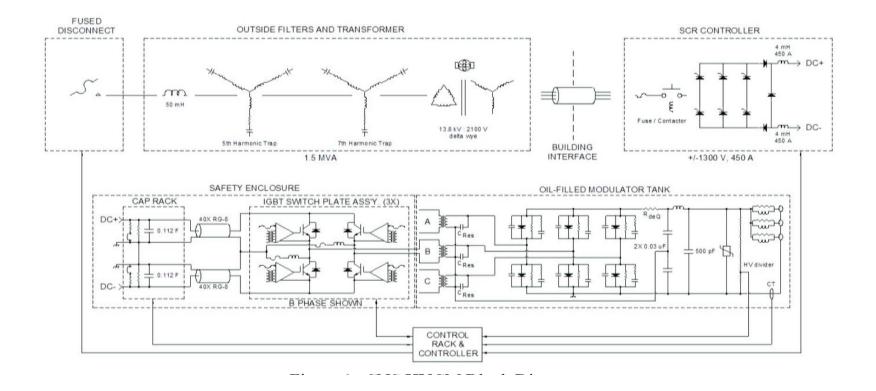








H-bridge Converter/Modulator @ SNS







Provides up to 135 kV, 1.35 ms pulses at 60 Hz to amplify RF to 5 MW

Powers multiple klystrons up to 11 MW peak power

Multi-phase H-bridges driving step-up transformers

Switching frequency of the IGBTs is 20 kHz

Currently there is up to a 5% pulse droop operating in open-loop, requires feedback loop

Slide courtesy of D. Anderson







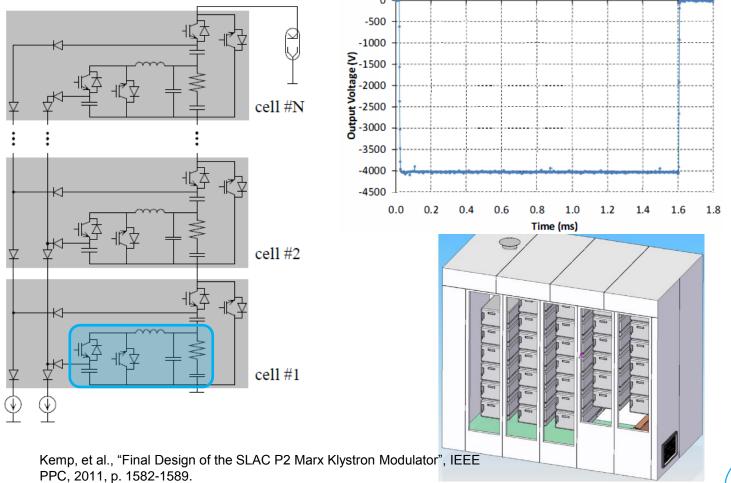




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Modular, redundant variation of traditional Marx Incorporates "nested" droop correction (buck converter) shown in light blue





Slide courtesy of D. Anderson

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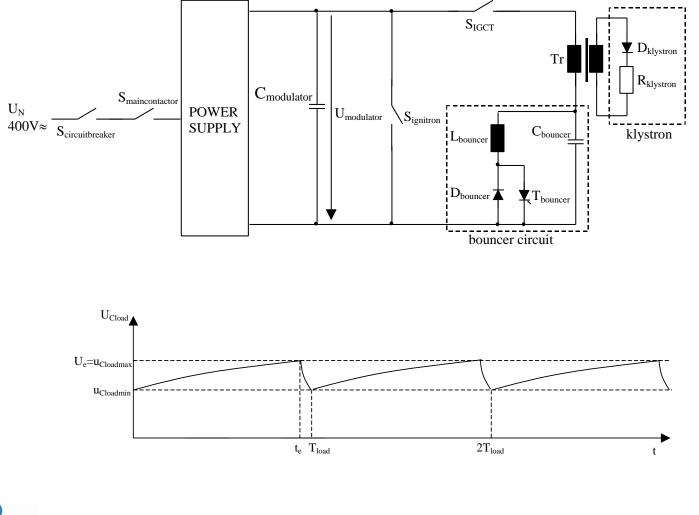


Connection to the mains





Bouncer Modulator







- The amount of allowed disturbances is defined in the German standard VDE 0838, IEC 38 or the equivalent European standard EN 61000-3-3.
- No energy consumer is allowed to produce more distortions than 3% of the voltage variation of the mains.
- For low frequencies in the visual spectrum this value is even more restricted. The low frequencies are called flicker frequencies. The human eye is very sensitive to changes in light intensities in this frequency domain.
- It is defined as voltage changes per minute.
- This is not to be confused with the frequency since a change is from top to bottom and vice versa

voltage changes / min = 2*frep [1/s]*60 [s/min]





Allowed disturbancies to the grid according to DIN EN 61000-3-3



DIN EN 61000-3-3 (VDE 0838-3):2014-03 EN 61000-3-3:2013





Disturbances to the mains



$$d = \frac{\Delta S}{S_{sc}} = \frac{\Delta U}{U_n} = 0.28 \%$$

d= allowed distortion of the voltage ΔS = variation in apparent power Ssc = short circuit power



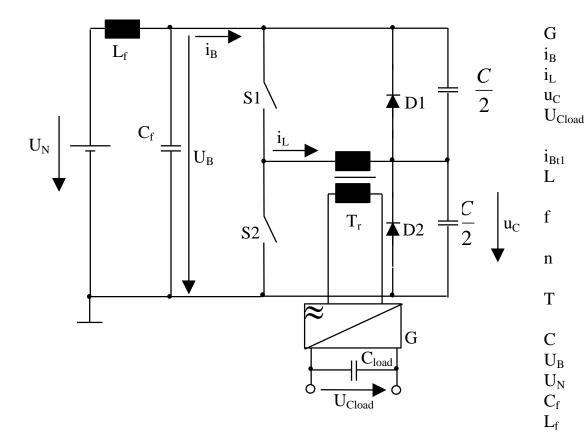


- > At DESY the intermediate voltage is 10 kV.
- The short circuit power of the mains station to which the modulators are connected to is 250 MVA.
 - 250 MVA * 0,28%=700 kVA
- The first assumption for the XFEL was that max. 35 modulators could be in operation.
 - Budget of 20 kVA/Modulator
 - This budget was cut by two since other components in the machine are assumed more critical than the human eye
 - 10 kVA per modulator





300 kW-Switched mode supply for constant power developed by N. Heidbrook

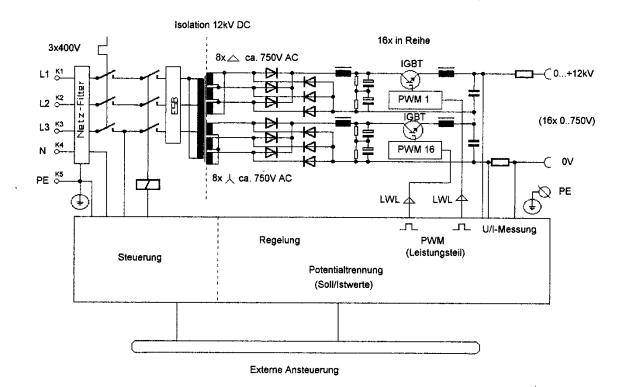


- Rectifier
- supply current
- primary current of the transformer voltage of the resonance capacitor output voltage to the switch of the klystron
- current i_B at the time t1
- primary stray inductivity of the transformer
 - resonance frequency of the resonant circuit of L and C
- gear ratio of the transformer and rectifier
- period time of the switching frequency of S1 and S2
- resonance capacitor
- supply voltage
- line voltage
- filter capacitor
- filter inductance





Series connection of buck converters

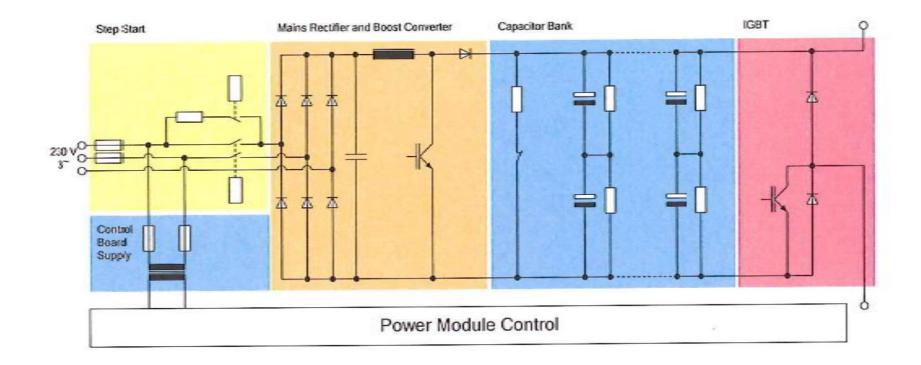


Constant power regulation was done with an analog circuit





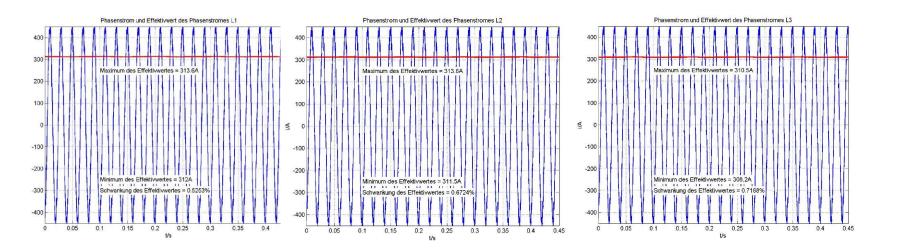
Ampegon Power Module







Variation of the mains current Ampegon modulator



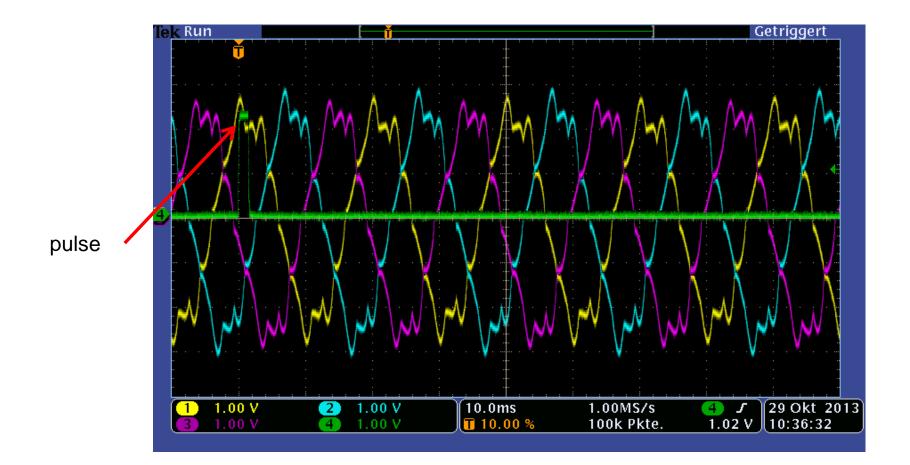
The 10 Hz reprate is suppressed very well. The value of specification would lead to $\Delta I = \frac{\Delta S}{\sqrt{3}*U} = \frac{10kVA}{\sqrt{3}*690V} = 8.4 A,$

Measured result $\Delta I = 2.5 \text{ A beeing } \Delta S \approx 3 \text{ kVA}$





Curve forms taken at commissioning





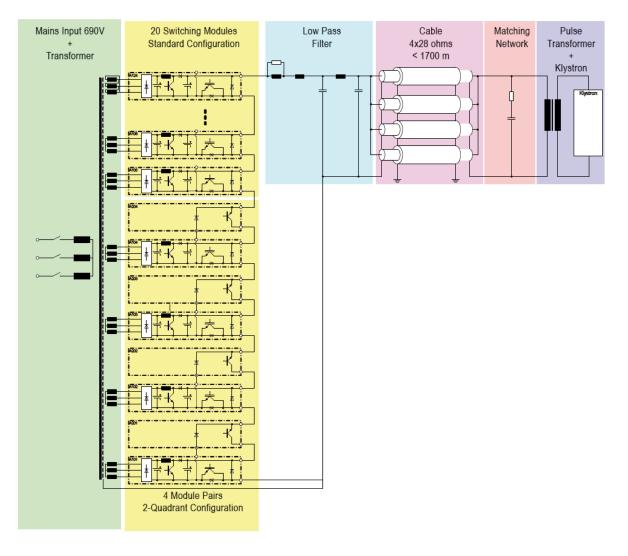


EMI effects





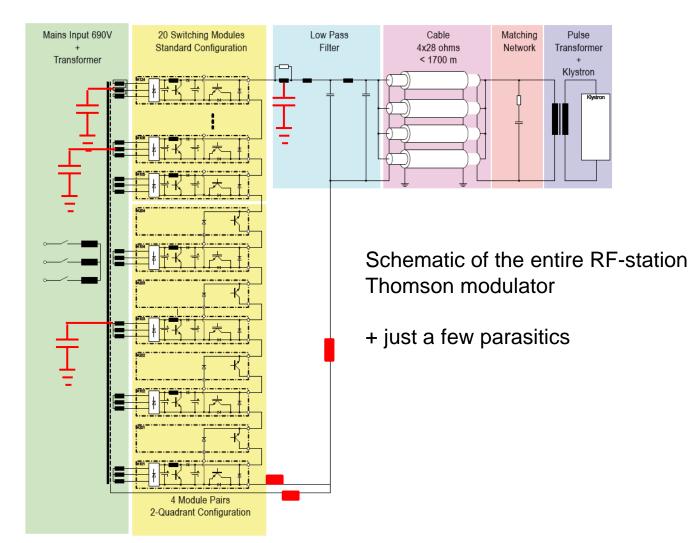
Example for EMI thinking







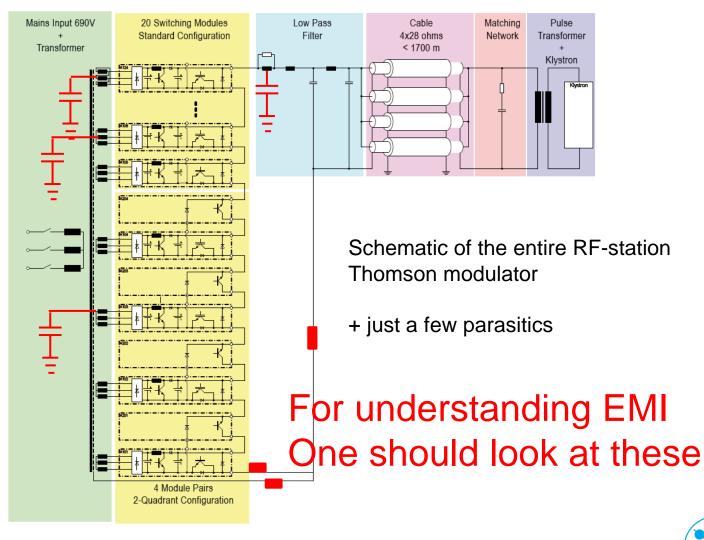
Example for EMI thinking







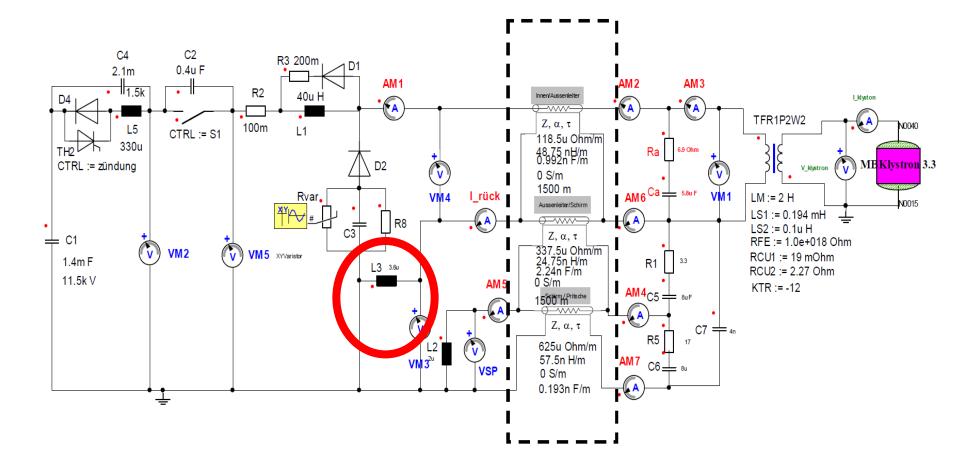
Example for EMI thinking







Bouncer Modulator with pulse cables



In the inductances the rise time of the current is transformed in voltages.





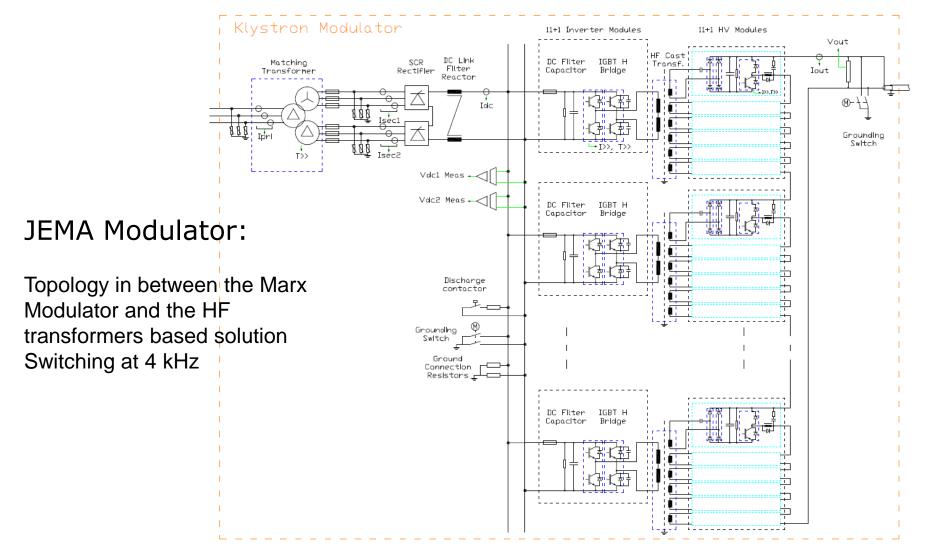
Near Future

- With the availability of new semiconductor devices new topologies can be chosen.
- > Higher switching frequencies are possible.
- > The general trend is to lower voltage components
- The large pulse transformer seems to be replaced by smaller HF transformers





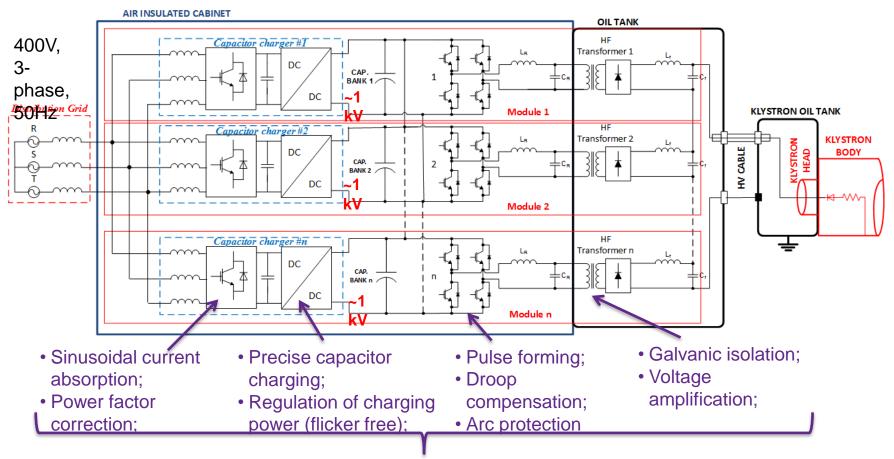
Hybrid Inverter Marx System with Custom Potted Transformers





The Stacked Multi-Level (SML) topology

Proposal by Carlos A. Martins ESS

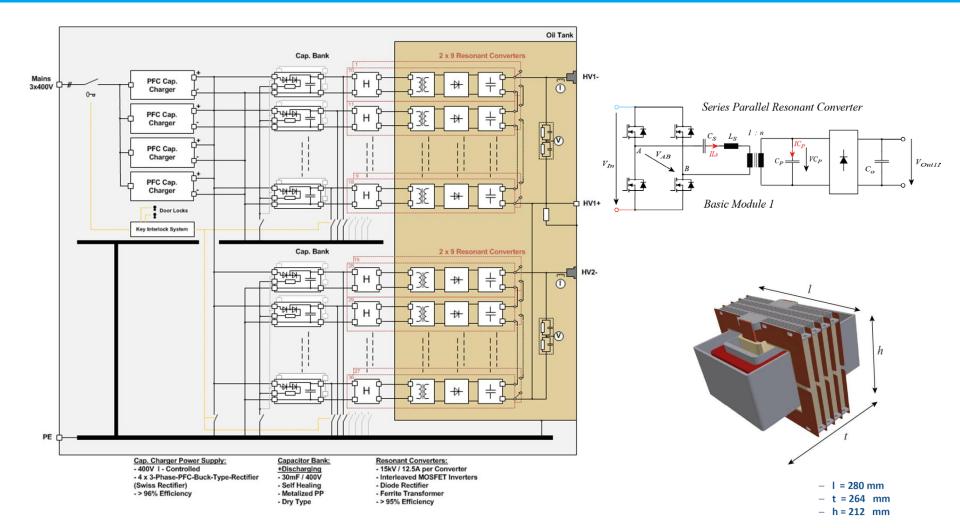


Modulator main functions by sub-system





Ampegon proposal for ESS modulator Switching at 100 kHz







Conclusion

- A lot of interesting R&D was done the last few years and different topologies are available on the market
- There is a lot of development ongoing in the near future which is possible to new and better semiconductors.
- > In the near future several large projects will use long pulse modulators:
 - XFEL commissioning
 - European Spallation Source
 - International Linear Collider
 - Project X
 - CLIC

Power electronic engineers will have a lot of fun.





Questions?!





More values of the modulator

>
$$I_{rms} = \sqrt{\frac{1}{T} \int_{t0}^{t0+T} (i(t))^2 dt}$$

> $I_{rms} = \sqrt{\frac{1}{T} * I_0^2 * t}$

>
$$P_{mod out} = \frac{P_{pulse}*t}{T}$$

> $P_{mod in} = \frac{P_{pulse}*t}{T} * T$





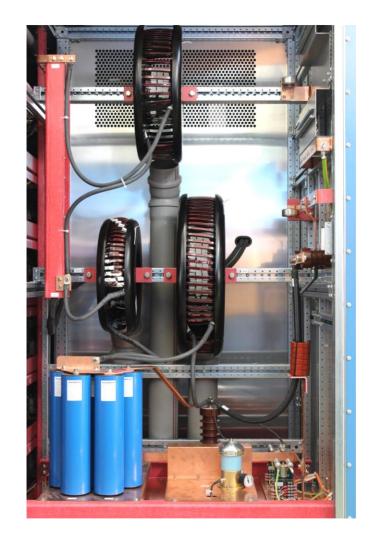
Ampegon modulator prototype







Ampegon new output filter with solenoid chokes







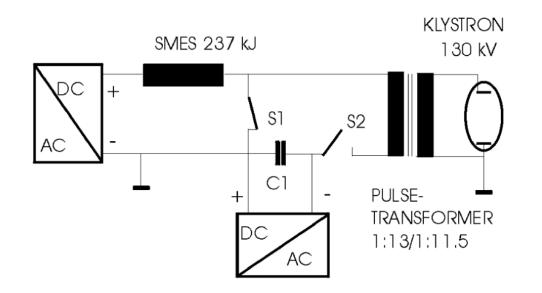
PPT Modulator with FuG constant power power supply







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Prototype built but has not been approved for accelerator use



